

IN THE CLAIMS

Please amend the claims as follows.

1-24. (Canceled)

25. (Currently Amended) An optoelectronic module comprising:

a stepped substrate having a lower portion and an upper portion;

a thermo-electric cooler disposed on the lower portion, wherein the thermo-electric cooler has a top portion and a bottom portion, wherein the bottom portion of the thermo-electric cooler is T-shaped, and wherein the T-shaped bottom portion ~~has~~ allows a plurality of cavities to be defined, wherein the cavities configured to route ~~for~~ electrical traces to the thermo-electric cooler contribute to compactness of a footprint of the module;

a laser light source disposed on the top portion of the thermo-electric cooler;

26. (Currently Amended) The module of claim 25, further comprising an electrical connection to the laser light source, and a structure defining an enclosed environment and including the substrate, wherein:

the substrate is at least partially disposed in the enclosed environment; and

the thermo electric cooler, the laser light source and the electrical connection are disposed in the enclosed environment.

27. (Canceled)

28. (Currently Amended) The module of claim 25, ~~wherein further comprising~~ [[the]] a laser light control device that includes at least one of a driver and an amplifier.

29. (Currently Amended) The module of claim 25, wherein the thermo-electric cooler includes a plurality of elongated thermo-electric elements, the thermo-electric elements being disposed substantially in parallel between the top portion and the T-shaped bottom portion of the thermo-electric cooler.

30. (Canceled)

31. (Previously Presented) The module of claim 25, wherein the laser light source is disposed directly on the thermo-electric cooler.

32. (Previously Presented) The module of claim 25, wherein the substrate includes a substrate body and a plurality of vias extending through the substrate body, the vias being adapted to provide electrical connections to the thermo-electric cooler and to dissipate thermoelectricity from the thermo-electric cooler.

33. (Previously Presented) The module of claim 25, wherein the thermo-electric cooler has a height that is substantially the same as the upper portion of the substrate.

34. (Previously Presented) The module of claim 25, wherein the substrate includes a substrate body comprising a one-piece component.

35. (Canceled)

36. (Currently Amended) The module of claim 25, wherein the substrate includes a substrate body and a plurality of vias extending through the substrate body, the vias being adapted to provide electrical connections to ~~the~~a laser light control device.

37. (Previously Presented) The module of claim 25, wherein the laser light source emits light bundles in a direction substantially parallel with a top surface of the thermo-electric cooler, the module further including an optical device disposed on the substrate and adapted to redirect the light bundles from the direction substantially parallel with the top surface of the thermo-electric cooler to a direction that is substantially orthogonal to the top surface of the thermo-electric cooler.

38. (Previously Presented) The module of claim 37, wherein the optical device includes at least one of a mirror assembly and prisms.

39. (Previously Presented) The module of claim 37, wherein the optical device is disposed on the thermo-electric cooler.

40. (Previously Presented) The module of claim 25, wherein the substrate includes a ceramic material.

41. (Canceled)

42. (Previously Presented) The module of claim 25, wherein the laser light source comprises one of a vertical cavity surface-emitting laser device, a Fabry-Perot laser device, a distributed feedback laser device, and a laser diode device.
43. (Previously Presented) The module of claim 26, further including a cap partially defining the enclosed environment, the cap being disposed on the substrate.
44. (Previously Presented) The module of claim 43, further comprising an overhanged ring disposed on a perimeter of the substrate and supporting the cap thereon.
45. (Previously Presented) The module of claim 43, wherein the cap includes an optical window adapted to facilitate an exit of laser light bundles from the enclosed space.
46. (Previously Presented) The module of claim 45, wherein the optical window includes one of a flat glass window, a ball lens, an aspherical lens, and a GRIN lens.
47. (Previously Presented) The module of claim 26, further comprising a laser light control device disposed on the upper portion of the stepped the substrate and in the enclosed environment, an electrical connection electrically coupling the laser light control device to the laser light source, wherein the substrate includes a substrate body and a plurality of first vias extending through the substrate body, the first vias being adapted to provide electrical connections to the thermo-electric cooler and to dissipate thermoelectricity from the thermo-electric cooler; and

a plurality of second vias extending through the substrate body, the second vias being adapted to provide electrical connections to the laser light control device.